LF0805A252R-10

PHYSICAL DIMENSIONS:

A 2.00 [.079] ± 0.20 [.008]

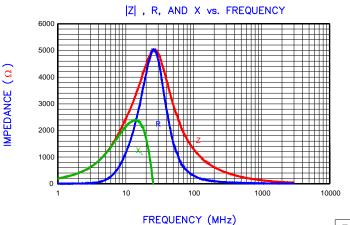
B 1.25 [.049] ± 0.20 [.008]

C 1.25 [.049] ± 0.20 [.008]

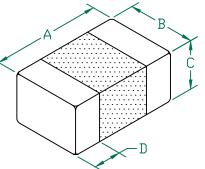
D 0.51 [.020] ± 0.25 [.010]

Z vs FREQUENCY IMPEDANCE UNDER DC BIAS 6000 4000 4000 -0.04A -0.06A -0.08A -0.08A -0.08A 1000 1000 1000 1000 1000

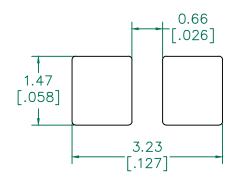
FREQUENCY (MHz)



AGILENT E4991A RF Impedance/Material Analyzer HP 16194A Test Fixture. TEST REF. 5806



LAND PATTERNS FOR REFLOW SOLDERING



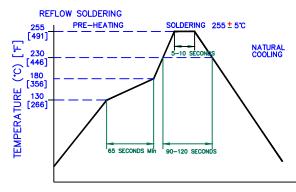
(For wave soldering, add 0.763 [.030] to this dimension.)

ELECTRICAL CHARACTERISTICS:								
Z @ 10MHz (Ω)		DCR (Ω)	Rated Current					
Nominal	2500							
Minimum	1875							
Maximum	3125	1.25	100 mA					

NOTES: UNLESS OTHERWISE SPECIFIED

- 1. TAPED AND REELED per CURRENT EIA SPECIFICATIONS 7" REELS, EMBOSSED PLASTIC TAPE 2,000 PCS/REEL.
- 2. TERMINATION FINISH 100% MATTE TIN.
- 3. COMPONENTS SHOULD BE ADEQUATELY PREHEATED BEFORE SOLDERING.
- OPERATING TEMP. RANGE: -40°C~+125°C. (INCLUDING SELF-HEATING)
- 5. COSMETIC SPECIFICATION REFER TO WI-QA-124.

 RECOMMENDED SOLDERING CONDITIONS



	DIMENSIONS ARE IN mm [INCHES].			This print is the property of Laird			
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-				rights to design or invention are reserved.			
-			-	PROJECT/PART NUMBER:	REV	PART TYPE:	DRAWN BY:
С	ADD OPERATING TEMPERATURE UPDATE LAIRD LOGO AND REFLOW CURVE	08/05/13	QU	LF0805A252R-10	С	CO-FIRE	JRK
В		07/03/08		DATE: 06/15/06 SCAL	E NTS	SHEET:	
A	ORIGINAL DRAFT	09/13/06	JRK				
REV	DESCRIPTION	DATE	INT	CAD # 1000	* -	1	of 1